

DATA SHEET

BFR93A **NPN 6 GHz wideband transistor**

Product specification

1997 Oct 29

Supersedes data of September 1995

File under discrete semiconductors, SC14

NPN 6 GHz wideband transistor**BFR93A****FEATURES**

- High power gain
- Low noise figure
- Very low intermodulation distortion.

APPLICATIONS

- RF wideband amplifiers and oscillators.

DESCRIPTION

NPN wideband transistor in a plastic SOT23 package.
PNP complement: BFT93.

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector

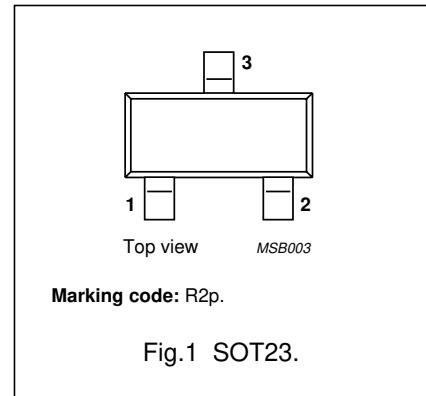


Fig.1 SOT23.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	15	V
V_{CEO}	collector-emitter voltage	open base	–	12	V
I_C	collector current (DC)		–	35	mA
P_{tot}	total power dissipation	$T_s \leq 95^\circ\text{C}$	–	300	mW
C_{re}	feedback capacitance	$I_C = 0$; $V_{CE} = 5$ V; $f = 1$ MHz	0.6	–	pF
f_T	transition frequency	$I_C = 30$ mA; $V_{CE} = 5$ V; $f = 500$ MHz	6	–	GHz
G_{UM}	maximum unilateral power gain	$I_C = 30$ mA; $V_{CE} = 8$ V; $f = 1$ GHz; $T_{amb} = 25^\circ\text{C}$	13	–	dB
		$I_C = 30$ mA; $V_{CE} = 8$ V; $f = 2$ GHz; $T_{amb} = 25^\circ\text{C}$	7	–	dB
F	noise figure	$I_C = 5$ mA; $V_{CE} = 8$ V; $f = 1$ GHz; $\Gamma_s = \Gamma_{opt}$; $T_{amb} = 25^\circ\text{C}$	1.9	–	dB
V_O	output voltage	$d_{im} = -60$ dB; $I_C = 30$ mA; $V_{CE} = 8$ V; $R_L = 75 \Omega$; $T_{amb} = 25^\circ\text{C}$; $f_p + f_q - f_r = 793.25$ MHz	425	–	mV

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	15	V
V_{CEO}	collector-emitter voltage	open base	–	12	V
V_{EBO}	emitter-base voltage	open collector	–	2	V
I_C	collector current (DC)		–	35	mA
P_{tot}	total power dissipation	$T_s \leq 95^\circ\text{C}$; note 1	–	300	mW
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature		–	+175	°C

Note

1. T_s is the temperature at the soldering point of the collector pin.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-s}$	thermal resistance from junction to soldering point	$T_s \leq 95^\circ\text{C}$; note 1	260	K/W

Note

1. T_s is the temperature at the soldering point of the collector pin.

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified.

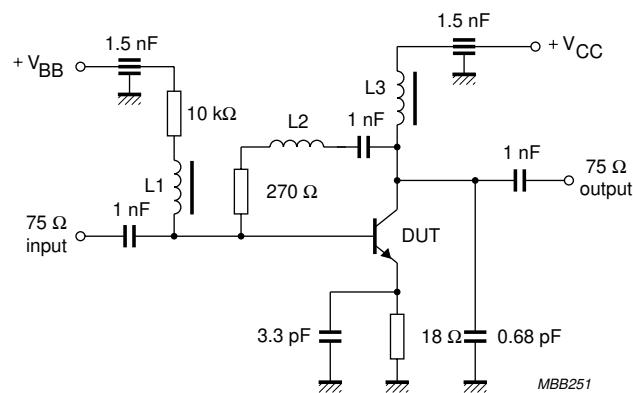
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0; V_{CB} = 5\text{ V}$	—	—	50	nA
h_{FE}	DC current gain	$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}$	40	90	—	
C_c	collector capacitance	$I_E = i_e = 0; V_{CB} = 5\text{ V}; f = 1\text{ MHz}$	—	0.7	—	pF
C_e	emitter capacitance	$I_C = i_c = 0; V_{EB} = 0.5\text{ V}; f = 1\text{ MHz}$	—	1.9	—	pF
C_{re}	feedback capacitance	$I_C = i_c = 0; V_{CE} = 5\text{ V}; f = 1\text{ MHz}; T_{amb} = 25^\circ\text{C}$	—	0.6	—	pF
f_T	transition frequency	$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}$	4.5	6	—	GHz
G_{UM}	maximum unilateral power gain (note 1)	$I_C = 30\text{ mA}; V_{CE} = 8\text{ V}; f = 1\text{ GHz}; T_{amb} = 25^\circ\text{C}$	—	13	—	dB
		$I_C = 30\text{ mA}; V_{CE} = 8\text{ V}; f = 2\text{ GHz}; T_{amb} = 25^\circ\text{C}$	—	7	—	dB
F	noise figure (note 2)	$I_C = 5\text{ mA}; V_{CE} = 8\text{ V}; f = 1\text{ GHz}; \Gamma_s = \Gamma_{opt}; T_{amb} = 25^\circ\text{C}$	—	1.9	—	dB
		$I_C = 5\text{ mA}; V_{CE} = 8\text{ V}; f = 2\text{ GHz}; \Gamma_s = \Gamma_{opt}; T_{amb} = 25^\circ\text{C}$	—	3	—	dB
V_O	output voltage	notes 2 and 3	—	425	—	mV
d_2	second order intermodulation distortion	notes 2 and 4	—	-50	—	dB

Notes

- G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and $G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)}$ dB.
- Measured on the same die in a SOT37 package (BFR91A).
- $d_{im} = -60\text{ dB}$ (DIN 45004B); $I_C = 30\text{ mA}; V_{CE} = 8\text{ V}; R_L = 75\Omega; T_{amb} = 25^\circ\text{C}$;
 $V_p = V_O$ at $d_{im} = -60\text{ dB}$; $f_p = 793.25\text{ MHz}$;
 $V_q = V_O - 6\text{ dB}$ at $f_q = 803.25\text{ MHz}$;
 $V_r = V_O - 6\text{ dB}$ at $f_r = 805.25\text{ MHz}$;
measured at $f_p + f_q - f_r = 793.25\text{ MHz}$.
- $I_C = 30\text{ mA}; V_{CE} = 8\text{ V}; R_L = 75\Omega; T_{amb} = 25^\circ\text{C}$;
 $V_p = 200\text{ mV}$ at $f_p = 250\text{ MHz}$;
 $V_q = 200\text{ mV}$ at $f_q = 560\text{ MHz}$;
measured at $f_p + f_q = 810\text{ MHz}$.

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$L_1 = L_3 = 5 \mu\text{H}$ choke.
 $L_2 = 3$ turns 0.4 mm copper wire; winding pitch 1 mm; internal diameter 3 mm.

Fig.2 Intermodulation distortion and second harmonic distortion MATV test circuit.

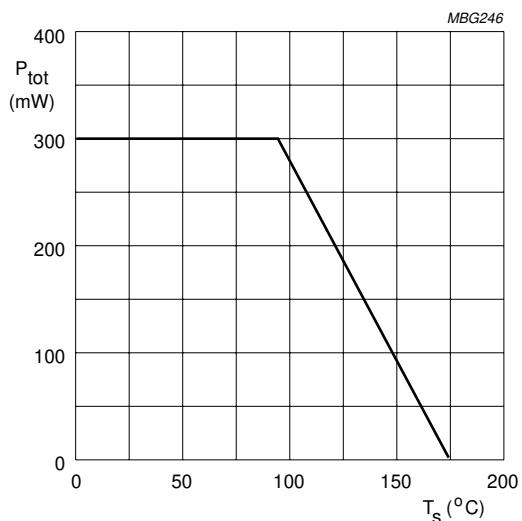
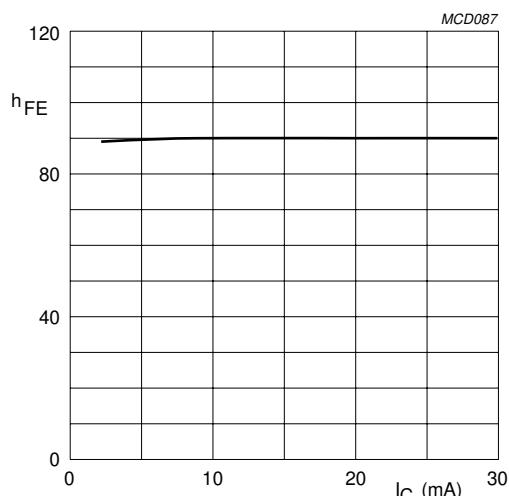


Fig.3 Power derating curve.



$V_{CE} = 5 \text{ V}; T_j = 25 \text{ }^\circ\text{C}.$

Fig.4 DC current gain as a function of collector current.

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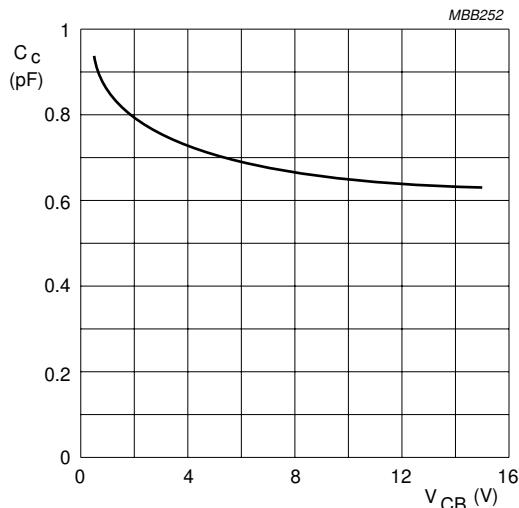
 $I_E = i_e = 0$; $f = 1$ MHz; $T_j = 25$ °C.

Fig.5 Collector capacitance as a function of collector-base voltage; typical values.

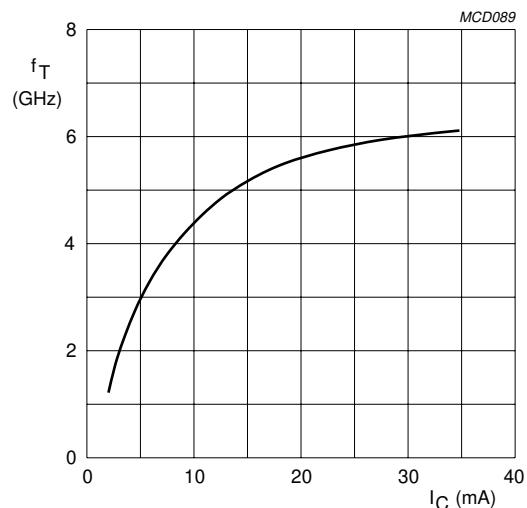
 $V_{CE} = 5$ V; $f = 500$ MHz; $T_j = 25$ °C.

Fig.6 Transition frequency as a function of collector current; typical values.

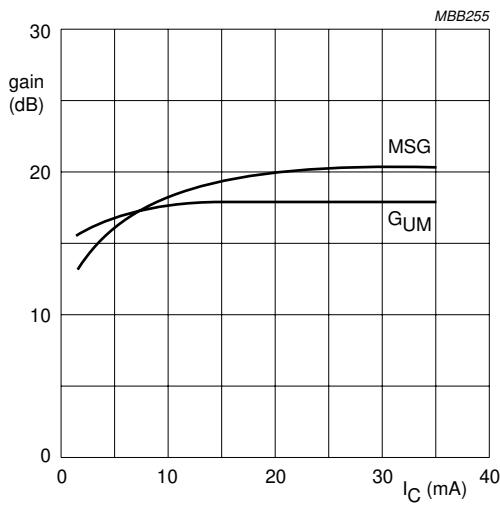
 $V_{CE} = 8$ V; $f = 500$ MHz.

Fig.7 Gain as a function of collector current; typical values.

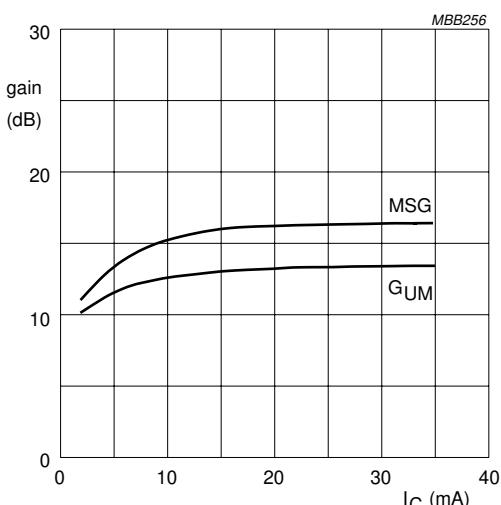
 $V_{CE} = 8$ V; $f = 1$ GHz.

Fig.8 Gain as a function of collector current; typical values.

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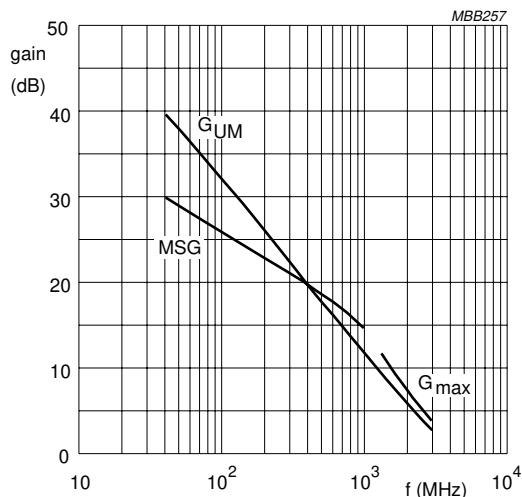
 $I_C = 10 \text{ mA}; V_{CE} = 8 \text{ V.}$

Fig.9 Gain as a function of frequency; typical values.

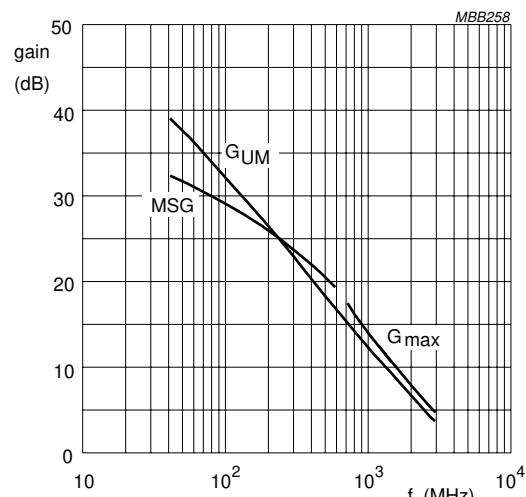
 $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V.}$

Fig.10 Gain as a function of frequency; typical values.

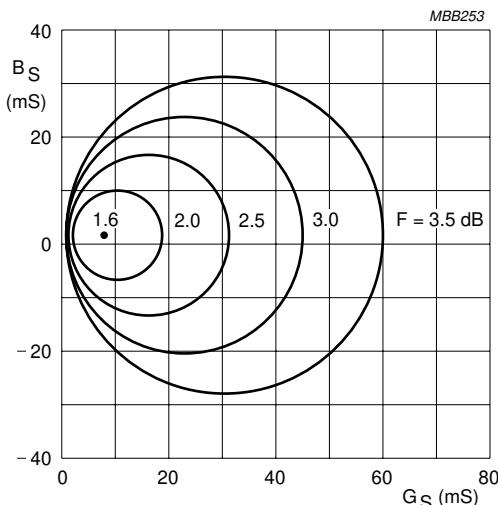
 $I_C = 4 \text{ mA}; V_{CE} = 8 \text{ V}; f = 800 \text{ MHz}; T_{amb} = 25^\circ\text{C.}$

Fig.11 Circles of constant noise figure; typical values.

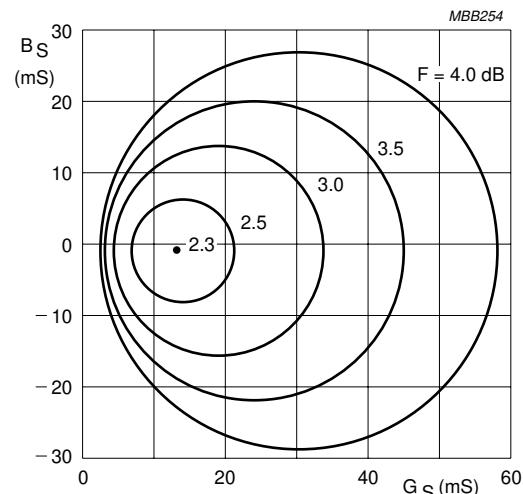
 $I_C = 4 \text{ mA}; V_{CE} = 8 \text{ V}; f = 800 \text{ MHz}; T_{amb} = 25^\circ\text{C.}$

Fig.12 Circles of constant noise figure; typical values.

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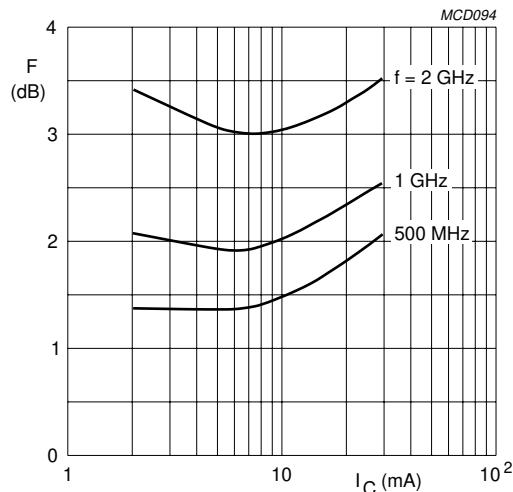
 $V_{CE} = 8 \text{ V}$.

Fig.13 Minimum noise figure as a function of collector current; typical values.

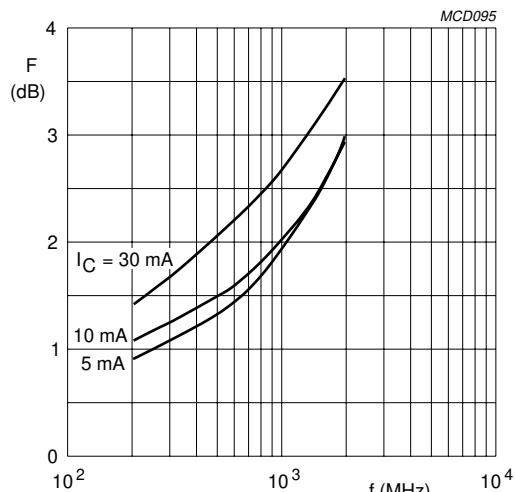
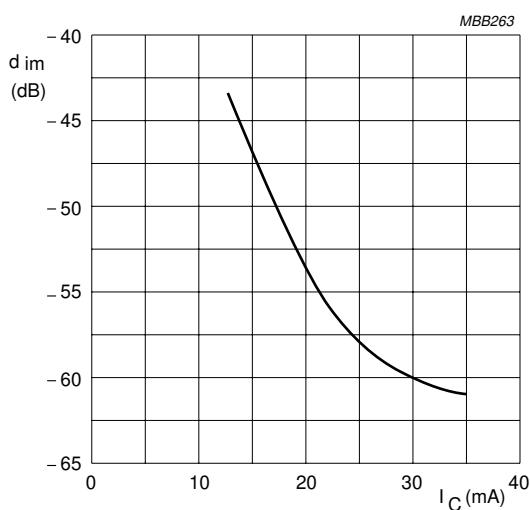
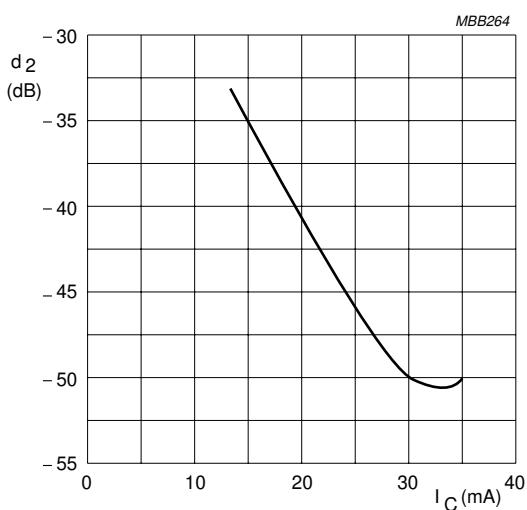
 $V_{CE} = 8 \text{ V}$.

Fig.14 Minimum noise figure as a function of frequency; typical values.



$V_{CE} = 8 \text{ V}; V_O = 425 \text{ mV} (52.6 \text{ dBmV})$;
 $f_p + f_q - f_r = 793.25 \text{ MHz}$; $T_{amb} = 25^\circ\text{C}$.
Measured in MATV test circuit (see Fig.2)

Fig.15 Intermodulation distortion; typical values.

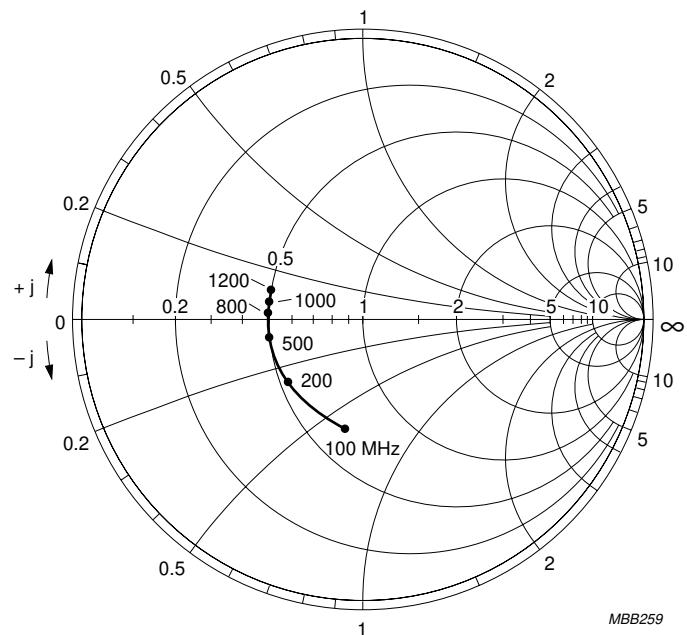
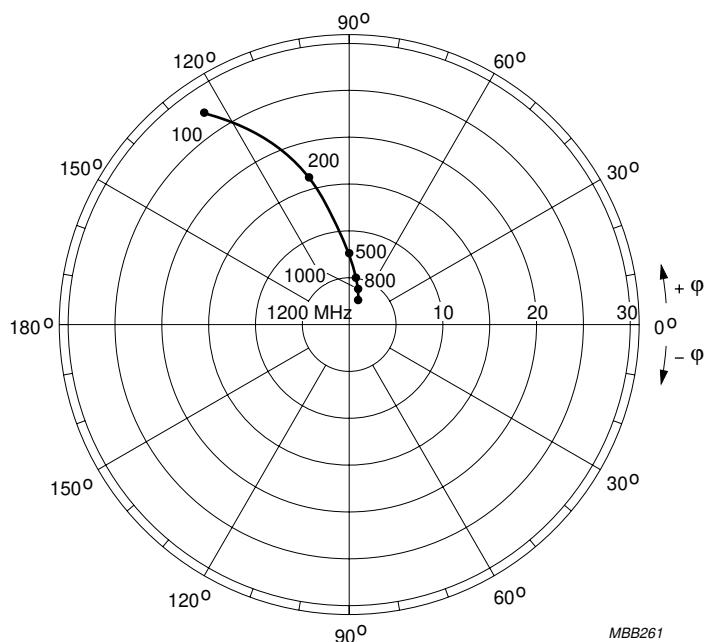


$V_{CE} = 8 \text{ V}; V_O = 200 \text{ mV} (46 \text{ dBmV})$;
 $f_p + f_q - f_r = 810 \text{ MHz}$; $T_{amb} = 25^\circ\text{C}$.
Measured in MATV test circuit (see Fig.2)

Fig.16 Second order intermodulation distortion; typical values.

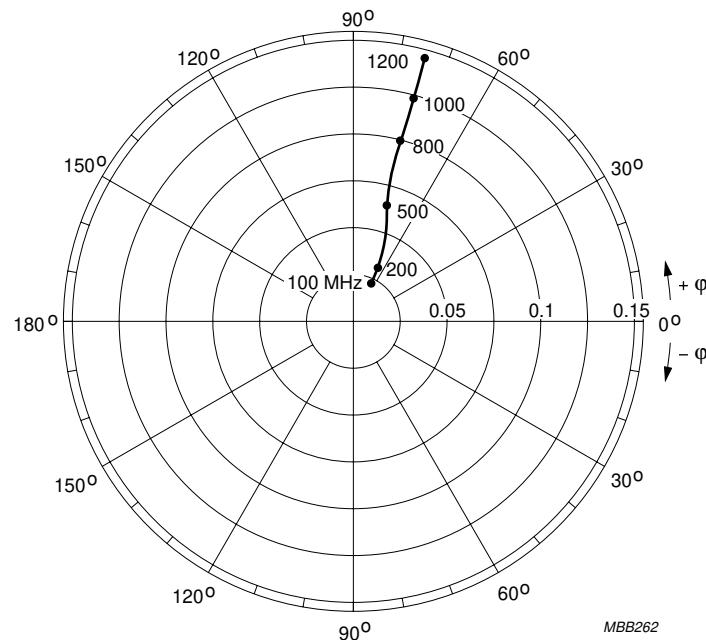
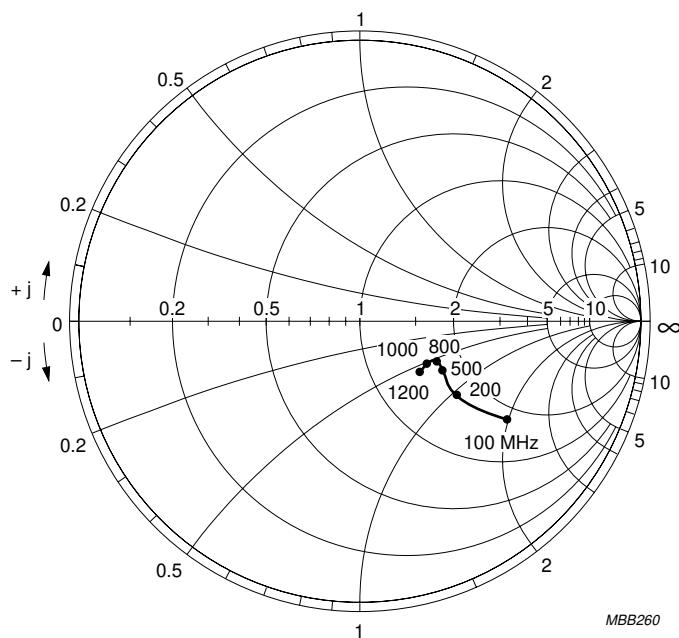
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 $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V}; Z_0 = 50 \Omega; T_{amb} = 25^\circ\text{C}.$ Fig.17 Common emitter input reflection coefficient (S_{11}). $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}.$ Fig.18 Common emitter forward transmission coefficient (S_{21}).

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 $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V}; T_{amb} = 25^\circ\text{C}.$ Fig.19 Common emitter reverse transmission coefficient (S_{12}). $I_C = 30 \text{ mA}; V_{CE} = 8 \text{ V}; Z_0 = 50 \Omega; T_{amb} = 25^\circ\text{C}.$ Fig.20 Common emitter output reflection coefficient (S_{22}).

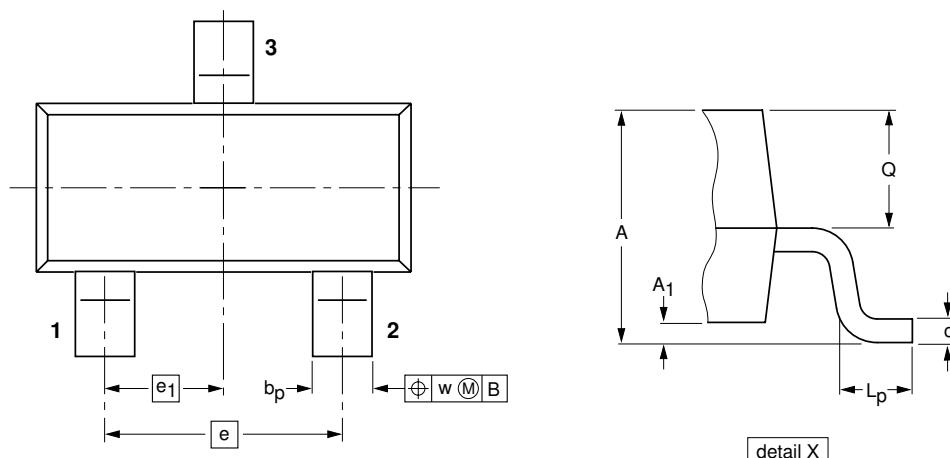
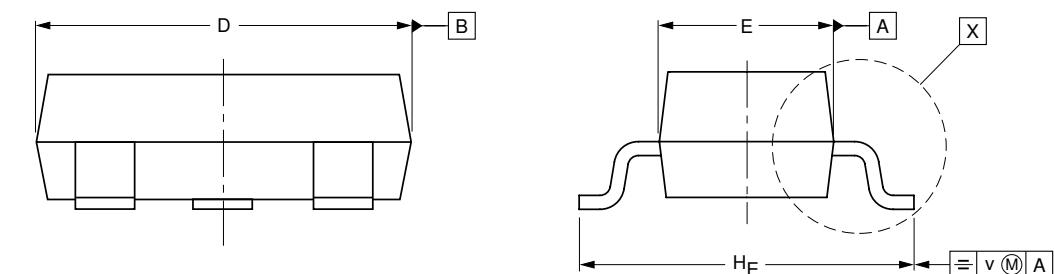
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



0 1 2 mm
scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max.	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT23						97-02-28

NPN 6 GHz wideband transistor**BFR93A****DEFINITIONS**

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113,
Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213, Tel. +43 1 60 1010,
Fax. +43 1 60 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 200 733, Fax. +375 172 200 773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 689 211, Fax. +359 2 689 102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,
Tel. +45 32 88 2636, Fax. +45 31 57 0044

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615800, Fax. +358 9 61580920

France: 4 Rue du Port-aux-Vins, BP317, 92156 SURESNES Cedex,
Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 23 53 60, Fax. +49 40 23 536 300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS,
Tel. +30 1 4894 339/239, Fax. +30 1 4814 240

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
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Tel. +91 22 493 8541, Fax. +91 22 493 0966

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Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St. PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3,
20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108,
Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA,
Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain

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Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 1231,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

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South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000,
Tel. +27 11 470 5911, Fax. +27 11 470 5494

South America: Rua do Rocio 220, 5th floor, Suite 51,
04552-903 São Paulo, SÃO PAULO - SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 829 1849

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 3 301 6312, Fax. +34 3 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM,
Tel. +46 8 632 2000, Fax. +46 8 632 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
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Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2865, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
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Tel. +66 2 745 4090, Fax. +66 2 398 0793

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Tel. +90 212 279 2770, Fax. +90 212 282 6707

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
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United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
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